PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Nobuki TANAKA	10/07/2010
Seiji MORI	10/07/2010

RECEIVING PARTY DATA

Name:	SUMITOMO BAKELITE COMPANY, LTD.		
Street Address:	5-8, Higashishinagawa 2-chome, Shinagawa-ku		
City:	Tokyo		
State/Country:	JAPAN		
Postal Code:	1400002		

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12902505	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: P4778US00

NAME OF SUBMITTER: Masayasu Mori

Total Attachments: 3

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PATENT

REEL: 025410 FRAME: 0627

OF \$40.00 12902503

Attorney Docket No.:

Client Docket No.: 090947US

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we the undersigned, Nobuki TANAKA, and Seiji Mori, hereby sell, assign, and transfer to SUMITOMO BAKELITE COMPANY, LTD., a corporation of Japan, having a principal place of business at 5-8, Higashishinagawa 2-chome, Shinagawa-ku, Tokyo, 1400002 Japan ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements that are disclosed in the application for the United States patent, entitled:

EPOXY RESIN COMPOSITION, PREPREG, METAL-CLAD LAMINATE, PRINTED WIRING BOARD AND SEMICONDUCTOR DEVICE

which has been executed by the undersigned concurently herewith,					
✓ which was filed on	October 12, 2010	and assigned Serial No.	12/902,505		

and in to said application and all divisional, continuing, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

agree that said Assignee may apply for and receive a patent or patents for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all assignments and powers of attorney; communicate to said Assignee, its successors, assigns, and representatives all facts known to the undersigned relating to said improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or representatives in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Each Inventor: Pl	ease Sign <u>and</u>	<u>Date</u> Below:
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Nobaki Tanaka October 7, 2010
Date

Name: Nobuki TANAKA

Each Inventor: Please Sign and Date Below:

October 7, 20 60 Seiji Mori

Name: Seiji MORI

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